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Bib Data Sheet

**CONFIRMATION NO. 8122**

SERIAL NUMBER 10/672,152	FILING DATE 09/25/2003  RULE	CLASS 438	GROUP ART UNIT 2814	ATTORNEY DOCKET NO. 42P12754D
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a DIV of 10/015,618 12/17/2001 PAT 6,667,225

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

*None*

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 12/18/2003

Foreign Priority claimed

☐ yes ☒ no

35 USC 119 (a-d) conditions met

☒ yes ☐ no☐ Met after Allowance

Verified and Acknowledged

Examiner's Signature

Initials

STATE OR

COUNTRY

CA

SHEETS

DRAWING

10

TOTAL

CLAIMS

3

INDEPENDENT

CLAIMS

1

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## TITLE

Wafer-bonding using solder and method of making the same

FILING FEE  RECEIVED 750	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
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